

CMOS single-chip 8-bit microcontroller

83C504/87C504

DESCRIPTION

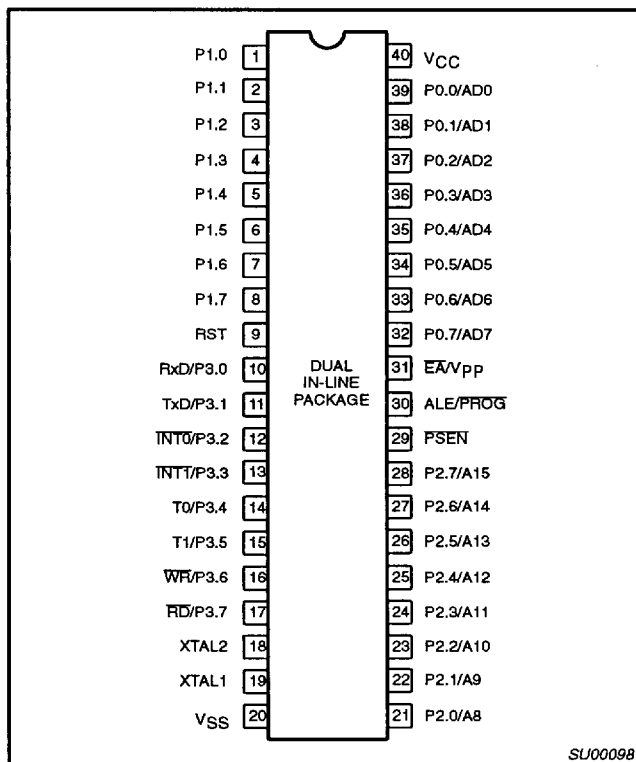
The 83C504 and 87C504 (hereafter referred to as 8XC504) Single-Chip 8-Bit Microcontroller is manufactured in an advanced CMOS process and is a derivative of the 80C51 microcontroller family. The 8XC504 has the same instruction set as the 80C51.

This device provides architectural enhancements that make it applicable in a variety of applications for general control systems. The 8XC504 contains 16k × 8 EPROM memory, the 83C504 contains 16k × 8 ROM memory, a volatile 256 × 8 read/write data memory, four 8-bit I/O ports, two 16-bit timer/event counters, a multi-source, two-priority-level, nested interrupt structure, a 24-by-8 bit unsigned divide, an enhanced UART and on-chip oscillator and timing circuits. For systems that require extra capability, the 8XC504 can be expanded using standard TTL compatible memories and logic.

FEATURES

- 80C51 central processing unit
- 16k × 8 EPROM expandable externally to 64k bytes
 - Quick Pulse programming algorithm
 - Two level program security system
- 256 × 8 RAM, expandable externally to 64k bytes
- Two 16-bit timer/counters
- Four 8-bit I/O ports
- Full-duplex enhanced UART
 - Framing error detection
 - Automatic address recognition
- Power control modes
 - Idle mode
 - Power-down mode
- Once (On Circuit Emulation) Mode
- Five package styles
- OTP package available
- 24-by-8 bit divide
 - Requires 8 machine cycles
 - 24-bit quotient and 8-bit remainder

PIN CONFIGURATIONS



SU00098

ORDERING INFORMATION

ROM	EPROM ¹		TEMPERATURE RANGE °C AND PACKAGE	FREQ. (MHz)	DRAWING NUMBER
P83C504IBP N	P87C504IBP N	OTP	0 to +70, 40-Pin Plastic Dual In-line Package	3.5 to 24	SOT129-1
	P87C504IBF FA	UV	0 to +70, 40-Pin Ceramic Dual In-line Package w/Window	3.5 to 24	0590B
P83C504IBA A	P87C504IBA A	OTP	0 to +70, 44-Pin Plastic Leaded Chip Carrier	3.5 to 24	SOT187-2
	P87C504IBL KA	UV	0 to +70, 44-Pin Ceramic Leaded Chip Carrier w/Window	3.5 to 24	1472A
P83C504IBB BD	P87C504IBB BD	OTP	0 to +70, 44-Pin Thin Quad Flat Pack	3.5 to 24	SOT389-1

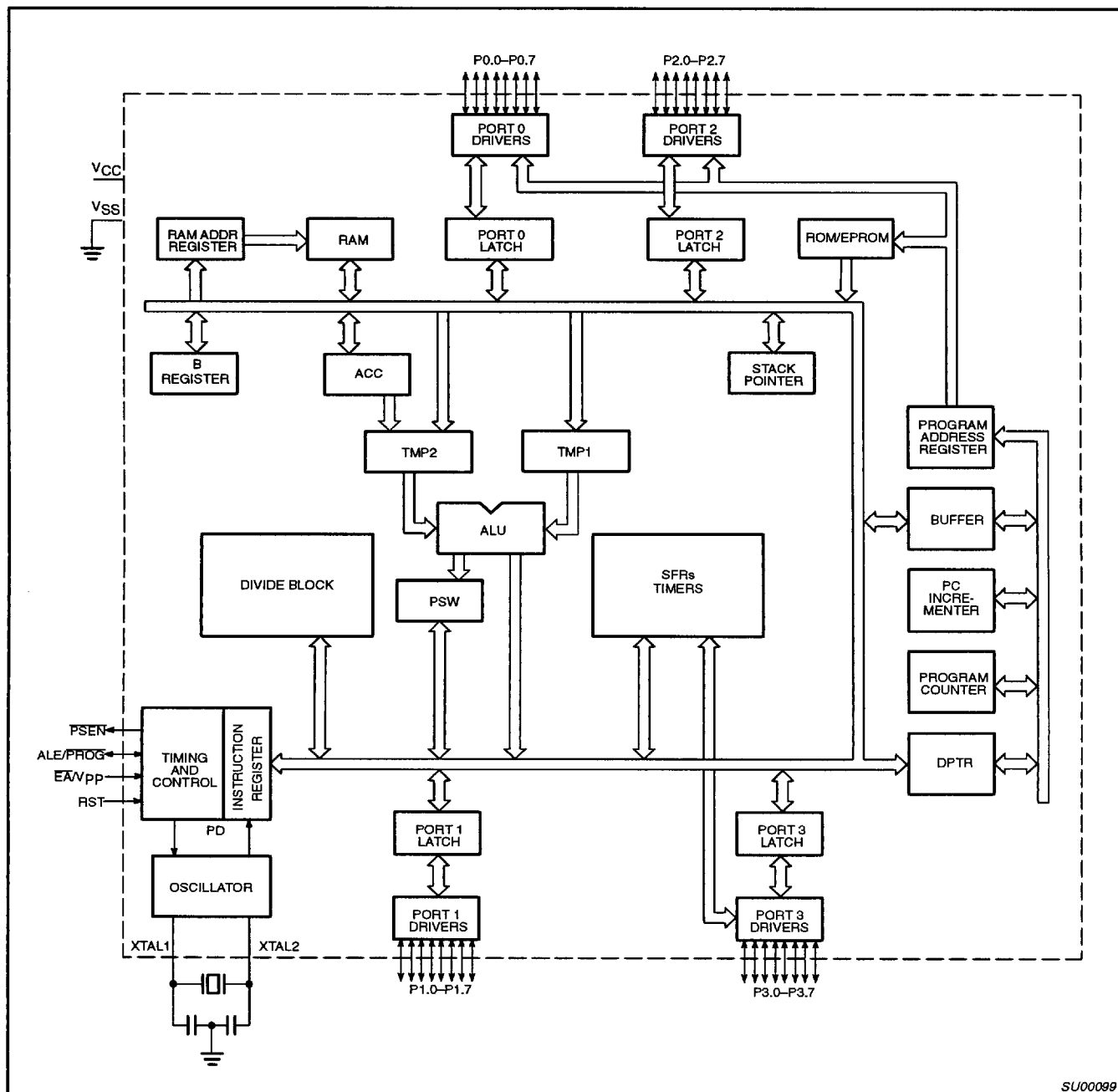
NOTE:

1. OTP = One Time Programmable EPROM. UV = Erasable EPROM.

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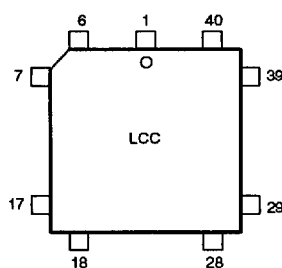
BLOCK DIAGRAM



SU00089

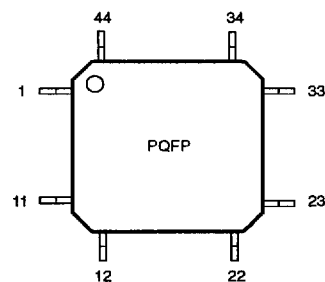
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CERAMIC AND PLASTIC LEADED CHIP CARRIER
PIN FUNCTIONS

Pin	Function	Pin	Function	Pin	Function
1	NC	16	P3.4/T0	31	P2.7/A15
2	P1.0	17	P3.5/T1	32	PSEN
3	P1.1	18	P3.6/WR	33	ALE/PROG
4	P1.2	19	P3.7/RD	34	NC
5	P1.3	20	XTAL2	35	EA/Vpp
6	P1.4	21	XTAL1	36	P0.7/AD7
7	P1.5	22	VSS	37	P0.6/AD6
8	P1.6	23	NC	38	P0.5/AD5
9	P1.7	24	P2.0/A8	39	P0.4/AD4
10	RST	25	P2.1/A9	40	P0.3/AD3
11	P3.0/RxD	26	P2.2/A10	41	P0.2/AD2
12	NC	27	P2.3/A11	42	P0.1/AD1
13	P3.1/TxD	28	P2.4/A12	43	P0.0/AD0
14	P3.2/INT0	29	P2.5/A13	44	VCC
15	P3.3/INT1	30	P2.6/A14		

SU00002

PLASTIC QUAD FLAT PACK
PIN FUNCTIONS

Pin	Function	Pin	Function	Pin	Function
1	P1.5	16	VSS	31	P0.6/AD6
2	P1.6	17	NC	32	P0.5/AD5
3	P1.7	18	P2.0/A8	33	P0.4/AD4
4	RST	19	P2.1/A9	34	P0.3/AD3
5	P3.0/RxD	20	P2.2/A10	35	P0.2/AD2
6	NC	21	P2.3/A11	36	P0.1/AD1
7	P3.1/TxD	22	P2.4/A12	37	P0.0/AD0
8	P3.2/INT0	23	P2.5/A13	38	VCC
9	P3.3/INT1	24	P2.6/A14	39	NC
10	P3.4/T0	25	P2.7/A15	40	P1.0
11	P3.5/T1	26	PSEN	41	P1.1
12	P3.6/WR	27	ALE/PROG	42	P1.2
13	P3.7/RD	28	NC	43	P1.3
14	XTAL2	29	EA/Vpp	44	P1.4
15	XTAL1	30	P0.7/AD7		

SU00003

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PIN DESCRIPTIONS

MNEMONIC	PIN NUMBER			TYPE	NAME AND FUNCTION
	DIP	LCC	QFP		
V _{SS}	20	22	16	I	Ground: 0V reference.
V _{CC}	40	44	38	I	Power Supply: This is the power supply voltage for normal, idle, and power-down operation.
P0.0–P0.7	39–32	43–36	37–30	I/O	Port 0: Port 0 is an open-drain, bidirectional I/O port. Port 0 pins that have 1s written to them float and can be used as high-impedance inputs. Port 0 is also the multiplexed low-order address and data bus during accesses to external program and data memory. In this application, it uses strong internal pull-ups when emitting 1s. Port 0 also outputs the code bytes during program verification and receives code bytes during EPROM programming. External pull-ups are required during program verification.
P1.0–P1.7	1–8	2–9	40–44, 1–3	I/O	Port 1: Port 1 is an 8-bit bidirectional I/O port with internal pull-ups, except P1.6 and P1.7 which are open drain. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 1 pins that are externally pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 1 also receives the low-order address byte during program memory verification.
P2.0–P2.7	21–28	24–31	18–25	I/O	Port 2: Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 2 pins that are externally being pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups when emitting 1s. During accesses to external data memory that use 8-bit addresses (MOV @Ri), port 2 emits the contents of the P2 special function register. Some Port 2 pins receive the high order address bits during EPROM programming and verification.
P3.0–P3.7	10–17	11, 13–19	5, 7–13	I/O	Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 3 pins that are externally being pulled low will source current because of the pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 3 also serves the special features of the 80C51 family, as listed below: RxD (P3.0): Serial input port TxD (P3.1): Serial output port INT0 (P3.2): External interrupt INT1 (P3.3): External interrupt T0 (P3.4): Timer 0 external input T1 (P3.5): Timer 1 external input WR (P3.6): External data memory write strobe RD (P3.7): External data memory read strobe
RST	9	10	4	I	Reset: A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to V _{SS} permits a power-on reset using only an external capacitor to V _{CC} .
ALE/PROG	30	33	27	I/O	Address Latch Enable/Program Pulse: Output pulse for latching the low byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory. This pin is also the program pulse input (PROG) during EPROM programming.
PSEN	29	32	26	O	Program Store Enable: The read strobe to external program memory. When the 8XC504 is executing code from the external program memory, PSEN is activated twice each machine cycle, except that two PSEN activations are skipped during each access to external data memory. PSEN is not activated during fetches from internal program memory.
EA/V _{PP}	31	35	29	I	External Access Enable/Programming Supply Voltage: EA must be externally held low to enable the device to fetch code from external program memory locations 0000H and 3FFFFH. If EA is held high, the device executes from internal program memory unless the program counter contains an address greater than 3FFFFH. This pin also receives the 12.75V programming supply voltage (V _{PP}) during EPROM programming. If security bit 1 is programmed, EA will be internally latched on Reset.
XTAL1	19	21	15	I	Crystal 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTAL2	18	20	14	O	Crystal 2: Output from the inverting oscillator amplifier.

NOTE:

To avoid "latch-up" effect at power-on, the voltage on any pin at any time must not be higher than V_{CC} + 0.5V or V_{SS} – 0.5V, respectively.

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Table 1. 87C504 Special Function Registers

SYMBOL	DESCRIPTION	DIRECT ADDRESS	BIT ADDRESS, SYMBOL, OR ALTERNATIVE PORT FUNCTION								RESET VALUE
			MSB							LSB	
ACC*	Accumulator	E0H	E7	E6	E5	E4	E3	E2	E1	E0	00H
AUXR#	Auxiliary	8EH	—	—	—	—	—	—	—	AO	xxxxxxx0B
B*	B register	F0H	F7	F6	F5	F4	F3	F2	F1	F0	00H
DPTR:	Data Pointer (2 bytes)										
DPH	Data Pointer High	83H									00H
DPL	Data Pointer Low	82H									00H
			FF	FE	FD	FC	FB	FA	F9	F8	
DCON	Divide Control	F8H	—	—	—	—	—	AUTOD	DSTRT	DCTRL	00H
DVND0	Dividend LSB	91H									00H
DVND1	Dividend Middle Byte	92H									00H
DVND2	Dividend MSB	93H									00H
DVSR	Divisor	95H									00H
			AF	AE	AD	AC	AB	AA	A9	A8	
IE*	Interrupt Enable	A8H	EA	—	—	ES	ET1	EX1	ET0	EX0	00H
			BF	BE	BD	BC	BB	BA	B9	B8	
IP*	Interrupt Priority	B8H	—	—	—	PS	PT1	PX1	PT0	PX0	x0000000B
			87	86	85	84	83	82	81	80	
P0*	Port 0	80H	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	FFH
			97	96	95	94	93	92	91	90	
P1*	Port 1	90H	—	—	—	—	—	—	—	—	FFH
			A7	A6	A5	A4	A3	A2	A1	A0	
P2*	Port 2	A0H	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8	FFH
			B7	B6	B5	B4	B3	B2	B1	B0	
P3*	Port 3	B0H	RD	WR	T1	T0	INT1	INT0	TxD	RxD	FFH
PCON	Power Control	87H	SMOD1	SMOD0	—	POF ¹	GF1	GF0	PD	IDL	00xxxx00B
			D7	D6	D5	D4	D3	D2	D1	D0	
PSW*	Program Status Word	D0H	CY	AC	F0	RS1	RS0	OV	—	P	00H
RMDR	Remainder	94H									00H
SADDR#	Slave Address	A9H									00H
SADEN#	Slave Address Mask	B9H									00H
SBUF	Serial Data Buffer	99H									xxxxxxx0B
			9F	9E	9D	9C	9B	9A	99	98	
SCON*	Serial Control	98H	SM0	SM1	SM2	REN	TB8	RB8	TI	RI	00H
SP	Stack Pointer	81H									07H
			8F	8E	8D	8C	8B	8A	89	88	
TCON*	Timer Control	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0	00H
TH0	Timer High 0	8CH									00H
TH1	Timer High 1	8DH									00H
TL0	Timer Low 0	8AH									00H
TL1	Timer Low 1	8BH									00H
TMOD	Timer Mode	89H	GATE	C/T	M1	M0	GATE	C/T	M1	M0	00H
			C7	C6	C5	C4	C3	C2	C1	C0	

* SFRs are bit addressable.

SFRs are modified from or added to the 80C51 SFRs.

1. Reset value depends on reset source.

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ENHANCED UART

The 8XC504 UART has all of the capabilities of the standard 80C51 UART plus Framing Error Detection and Automatic Address Recognition. As in the 80C51, all four modes of operation are supported as well as the 9th bit in modes 2 and 3 that can be used to facilitate multiprocessor communication.

The Framing Error Detection allows the UART to look for missing stop bits. If a Stop bit is missing, the FE bit in the SCON SFR is set. The FE bit can be checked after each transmission to detect communication errors. The FE bit can only be cleared by software and is not affected by a valid stop bit.

Automatic Address Recognition is used to reduce the CPU service time for the serial port. The CPU only needs to service the UART when it is addressed and, with this done by the on-chip circuitry, the need for software overhead is greatly reduced. This mode works similar to the 9th bit communication mode, except that uses only 8 bits and the Stop bit is used to cause the RI bit to be set. There are two SFRs associated with this mode. They are SADDR, which holds the slave address and SADEN, which contains a mask that allows selective masking of the slave address so that broadcast addresses can be used.

HARDWARE DIVIDE UNIT

The 8XC504 contains a 24-by-8 bit hardware divide unit. The 24 bit dividend is stored in special function registers DVND0 (LSB) – DVND2 (MSB) and the divisor is in register DVSR. A division operation returns the 24-bit result in the dividend registers (DVND0 – DVND2) and an 8-bit remainder in register RMDR.

The divide unit provides two modes of operation, auto-start and flag-controlled. Auto-start mode is enabled by setting the AUTOD (auto divide) bit in the DCON (divide control) register. If auto-start mode is enabled, writing to the divisor register (DVSR) will automatically start a division operation and will set the DCTRL (divide control) and DSTRT bits in the DCON register. DCTRL will automatically be cleared by the divide hardware when the division operation has been completed.

Flag controlled operation is initiated by setting the DCTRL bit in the DCON register which will start the division operation and also set the DSTRT bit. The DCTRL bit will automatically be cleared by the divide hardware when the division operation has been completed. DSTRT can only be cleared by software.

POWER OFF FLAG

The Power Off Flag (POF) is set by on-chip circuitry when the V_{CC} level on the 8XC504 rises from 0 to 5V. The POF bit can be set or cleared by software allowing a user to determine if the reset is the result of a power-on or a warm start after powerdown. The V_{CC} level must remain above 3V for the POF to remain unaffected by the V_{CC} level.

OSCILLATOR CHARACTERISTICS

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier. The pins can be configured for use as an on-chip oscillator.

To drive the device from an external clock source, XTAL1 should be driven while XTAL2 is left unconnected. There are no requirements on the duty cycle of the external clock signal, because the input to the internal clock circuitry is through a divide-by-two flip-flop. However, minimum and maximum high and low times specified in the data sheet must be observed.

Reset

A reset is accomplished by holding the RST pin high for at least two machine cycles (24 oscillator periods), while the oscillator is running. To insure a good power-on reset, the RST pin must be high long enough to allow the oscillator time to start up (normally a few milliseconds) plus two machine cycles. At power-on, the voltage on V_{CC} and RST must come up at the same time for a proper start-up.

Idle Mode

In the idle mode, the CPU puts itself to sleep while all of the on-chip peripherals stay active. The instruction to invoke the idle mode is the last instruction executed in the normal operating mode before the idle mode is activated. The CPU contents, the on-chip RAM, and all of the special function registers remain intact during this mode. The idle mode can be terminated either by any enabled interrupt (at which time the process is picked up at the interrupt service routine and continued), or by a hardware reset which starts the processor in the same manner as a power-on reset.

Power-Down Mode

To save even more power, a Power Down mode can be invoked by software. In this mode, the oscillator is stopped and the instruction that invoked Power Down is the last instruction executed. The on-chip RAM and Special Function Registers retain their values until the Power Down mode is terminated.

On the 8XC504 either a hardware reset or external interrupt can use an exit from Power Down. Reset redefines all the SFRs but does not change the on-chip RAM. An external interrupt allows both the SFRs and the on-chip RAM to retain their values.

To properly terminate Power Down the reset or external interrupt should not be executed before V_{CC} is restored to its normal operating level and must be held active long enough for the oscillator to restart and stabilize (normally less than 10ms).

With an external interrupt, INT0 and INT1 must be enabled and configured as level-sensitive. Holding the pin low restarts the oscillator but bringing the pin back high completes the exit. Once the interrupt is serviced, the next instruction to be executed after RETI will be the one following the instruction that put the device into Power Down.

Design Consideration

- When the idle mode is terminated by a hardware reset, the device normally resumes program execution, from where it left off, up to two machine cycles before the internal reset algorithm takes control. On-chip hardware inhibits access to internal RAM in this event, but access to the port pins is not inhibited. To eliminate the possibility of an unexpected write when Idle is terminated by reset, the instruction following the one that invokes Idle should not be one that writes to a port pin or to external memory.

ONCE™ Mode

The ONCE ("On-Circuit Emulation") Mode facilitates testing and debugging of systems using the 8XC504 without the 8XC504 having to be removed from the circuit. The ONCE Mode is invoked by:

1. Pull ALE low while the device is in reset and PSEN is high;
2. Hold ALE low as RST is deactivated.

While the device is in ONCE Mode, the Port 0 pins go into a float state, and the other port pins and ALE and PSEN are weakly pulled high. The oscillator circuit remains active. While the 8XC504 is in this mode, an emulator or test CPU can be used to drive the circuit. Normal operation is restored when a normal reset is applied.

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Table 2. External Pin Status During Idle and Power-Down Mode

MODE	PROGRAM MEMORY	ALE	PSEN	PORT 0	PORT 1	PORT 2	PORT 3
Idle	Internal	1	1	Data	Data	Data	Data
Idle	External	1	1	Float	Data	Address	Data
Power-down	Internal	0	0	Data	Data	Data	Data
Power-down	External	0	0	Float	Data	Data	Data

ABSOLUTE MAXIMUM RATINGS^{1, 2, 3}

PARAMETER	RATING	UNIT
Operating temperature under bias	0 to +70	°C
Storage temperature range	–65 to +150	°C
Voltage on EA/V _{PP} pin to V _{SS}	0 to +13.0	V
Voltage on any other pin to V _{SS}	–0.5 to +6.5	V
Maximum I _{OL} per I/O pin	15	mA
Power dissipation (based on package heat transfer limitations, not device power consumption)	1.5	W

NOTES:

1. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the AC and DC Electrical Characteristics section of this specification is not implied.
2. This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maxima.
3. Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

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DC ELECTRICAL CHARACTERISTICS

 $T_{amb} = 0^{\circ}\text{C to } 70^{\circ}\text{C}$; $V_{CC} = 5\text{V} \pm 10\%$, $V_{SS} = 0\text{V}$

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP ¹	MAX	
V_{IL}	Input low voltage, except $\overline{\text{EA}}$		-0.5		$0.2V_{CC} - 0.1$	V
V_{IL1}	Input low voltage to $\overline{\text{EA}}$		0		$0.2V_{CC} - 0.3$	V
V_{IH}	Input high voltage		$0.7V_{CC}$		$V_{CC} + 0.5$	V
V_{OL}	Output low voltage, ports 1, 2, 3 ⁸	$I_{OL} = 100\mu\text{A}$			0.3	V
		$I_{OL} = 1.6\text{mA}^2$			0.45	V
		$I_{OL} = 3.5\text{mA}$			1.0	V
V_{OL1}	Output low voltage, port 0, ALE, $\overline{\text{PSEN}}^3$	$I_{OL} = 200\mu\text{A}$			0.3	V
		$I_{OL} = 3.2\text{mA}^2$			0.45	V
		$I_{OL} = 7.0\text{mA}$			1.0	V
V_{OH}	Output high voltage, ports 1, 2, 3, ALE, $\overline{\text{PSEN}}^3$	$I_{OH} = -60\mu\text{A}$	$V_{CC} - 1.5$			V
		$I_{OH} = -30\mu\text{A}$	$V_{CC} - 0.7$			V
		$I_{OH} = -10\mu\text{A}$	$V_{CC} - 0.3$			V
V_{OH1}	Output high voltage (port 0 in external bus mode), ALE ⁹ , $\overline{\text{PSEN}}^3$	$I_{OH} = -7.0\text{mA}$	$V_{CC} - 1.5$			V
		$I_{OH} = -3.2\text{mA}$	$V_{CC} - 0.7$			V
		$I_{OH} = -200\mu\text{A}$	$V_{CC} - 0.3$			V
I_{IL}	Logical 0 input current, ports 1, 2, 3	$V_{IN} = 0.45\text{V}$			-50	μA
I_{TL}	Logical 1-to-0 transition current, ports 1, 2, 3	See note 4			-650	μA
I_{LI}	Input leakage current, port 0	$0.45 V_{IN} < V_{CC} - 0.3$			± 10	μA
I_{CC}	Power supply current: Active mode @ 16MHz ⁵ Idle mode @ 16MHz Power-down mode	See note 6		15	32	mA
				3	5	mA
				10	50	μA
R_{RST}	Internal reset pull-down resistor		50		225	$\text{k}\Omega$
C_{IO}	Pin capacitance ¹⁰ (except $\overline{\text{EA}}$)				15	pF

NOTES:

- Typical ratings are not guaranteed. The values listed are at room temperature, 5V.
- Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the V_{OL} s of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100pF), the noise pulse on the ALE pin may exceed 0.8V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. I_{OL} can exceed these conditions provided that no single output sinks more than 5mA and no more than two outputs exceed the test conditions.
- Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and $\overline{\text{PSEN}}$ to momentarily fall below the $0.9V_{CC}$ specification when the address bits are stabilizing.
- Pins of ports 1, 2 and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2V.
- I_{CCMAX} at other frequencies is given by: Active mode: $I_{CCMAX} = 1.50 \times \text{FREQ} + 8$; Idle mode: $I_{CCMAX} = 0.14 \times \text{FREQ} + 2.31$, where FREQ is the external oscillator frequency in MHz. I_{CCMAX} is given in mA. See Figure 8.
- See Figures 9 through 12 for I_{CC} test conditions.
- Load capacitance for port 0, ALE, and $\overline{\text{PSEN}} = 100\text{pF}$, load capacitance for all other outputs = 80pF.
- Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
Maximum I_{OL} per port pin: 15mA (*NOTE: This is 85°C specification.)
Maximum I_{OL} per 8-bit port: 26mA
Maximum total I_{OL} for all outputs: 71mA
If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.
- ALE is tested to V_{OH1} , except when ALE is off then V_{OH} is the voltage specification.
- Pin capacitance is less than 25pF. Pin capacitance of ceramic package is less than 15pF (except $\overline{\text{EA}}$ is 25pF).

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AC ELECTRICAL CHARACTERISTICS

 $T_{amb} = 0^{\circ}\text{C to } +70^{\circ}\text{C}$; $V_{CC} = 5\text{V} \pm 10\%$, $V_{SS} = 0\text{V}^{1, 2, 3}$

SYMBOL	FIGURE	PARAMETER	24MHz CLOCK		VARIABLE CLOCK ⁴		UNIT
			MIN	MAX	MIN	MAX	
$1/t_{CLCL}$	1	Oscillator frequency Speed versions : I			3.5	24	MHz
t_{LHLL}	1	ALE pulse width	43		$2t_{CLCL}-40$		ns
t_{AVLL}	1	Address valid to ALE low	17		$t_{CLCL}-25$		ns
t_{LLAX}	1	Address hold after ALE low	17		$t_{CLCL}-25$		ns
t_{LLIV}	1	ALE low to valid instruction in		102		$4t_{CLCL}-65$	ns
t_{LLPL}	1	ALE low to PSEN low	17		$t_{CLCL}-25$		ns
t_{PLPH}	1	PSEN pulse width	80		$3t_{CLCL}-45$		ns
t_{PLIV}	1	PSEN low to valid instruction in		65		$3t_{CLCL}-60$	ns
t_{PXIX}	1	Input instruction hold after PSEN	0		0		ns
t_{PXIZ}	1	Input instruction float after PSEN		17		$t_{CLCL}-25$	ns
t_{AVIV}	1	Address to valid instruction in		128		$5t_{CLCL}-80$	ns
t_{PLAZ}	1	PSEN low to address float		10		10	ns
Data Memory							
t_{RLRH}	2, 3	RD pulse width	150		$6t_{CLCL}-100$		ns
t_{WLWH}	2, 3	WR pulse width	150		$6t_{CLCL}-100$		ns
t_{RLDV}	2, 3	RD low to valid data in		118		$5t_{CLCL}-90$	ns
t_{RHDZ}	2, 3	Data hold after RD	0		0		ns
t_{RHDZ}	2, 3	Data float after RD		55		$2t_{CLCL}-28$	ns
t_{LLDV}	2, 3	ALE low to valid data in		183		$8t_{CLCL}-150$	ns
t_{AVDV}	2, 3	Address to valid data in		210		$9t_{CLCL}-165$	ns
t_{LLWL}	2, 3	ALE low to RD or WR low	75	175	$3t_{CLCL}-50$	$3t_{CLCL}+50$	ns
t_{AVWL}	2, 3	Address valid to WR low or RD low	92		$4t_{CLCL}-75$		ns
t_{QVWX}	2, 3	Data valid to WR transition	12		$t_{CLCL}-30$		ns
t_{WHQX}	2, 3	Data hold after WR	17		$t_{CLCL}-25$		ns
t_{QVWH}	3	Data valid to WR high	162		$7t_{CLCL}-130$		ns
t_{RLAZ}	2, 3	RD low to address float		0		0	ns
t_{WHLH}	2, 3	RD or WR high to ALE high	17	67	$t_{CLCL}-25$	$t_{CLCL}+25$	ns
External Clock							
t_{CHCX}	5	High time	17		17	$t_{CLCL} - t_{CLCX}$	ns
t_{CLCX}	5	Low time	17		17	$t_{CLCL} - t_{CLCX}$	ns
t_{CLCH}	5	Rise time		5		5	ns
t_{CHCL}	5	Fall time		5		5	ns
Shift Register							
t_{XLXL}	4	Serial port clock cycle time	505		$12t_{CLCL}$		ns
t_{QVXH}	4	Output data setup to clock rising edge	283		$10t_{CLCL}-133$		ns
t_{XHQX}	4	Output data hold after clock rising edge	3		$2t_{CLCL}-80$		ns
t_{XHDX}	4	Input data hold after clock rising edge	0		0		ns
t_{XHDX}	4	Clock rising edge to input data valid		283		$10t_{CLCL}-133$	ns

NOTES:

- Parameters are valid over operating temperature range unless otherwise specified.
- Load capacitance for port 0, ALE, and PSEN = 100pF, load capacitance for all other outputs = 80pF.
- Interfacing the 8XC504 to devices with float times up to 45ns is permitted. This limited bus contention will not cause damage to Port 0 drivers.
- Variable clock electrical limits are limited to a minimum oscillator frequency of 16MHz.

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EXPLANATION OF THE AC SYMBOLS

Each timing symbol has five characters. The first character is always 't' (= time). The other characters, depending on their positions, indicate the name of a signal or the logical status of that signal. The designations are:

A – Address
C – Clock
D – Input data
H – Logic level high
I – Instruction (program memory contents)
L – Logic level low, or ALE

P – PSEN
Q – Output data
R – RD signal
t – Time
V – Valid
W – WR signal
X – No longer a valid logic level
Z – Float

Examples: t_{AVLL} = Time for address valid to ALE low.
 t_{LLPL} = Time for ALE low to \overline{PSEN} low.

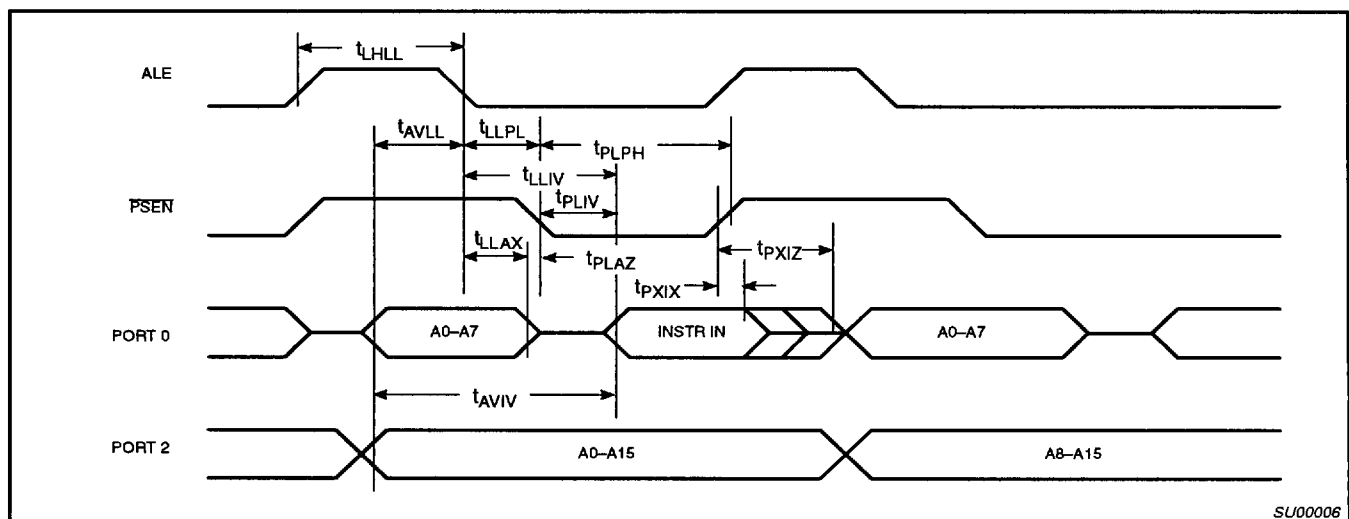


Figure 1. External Program Memory Read Cycle

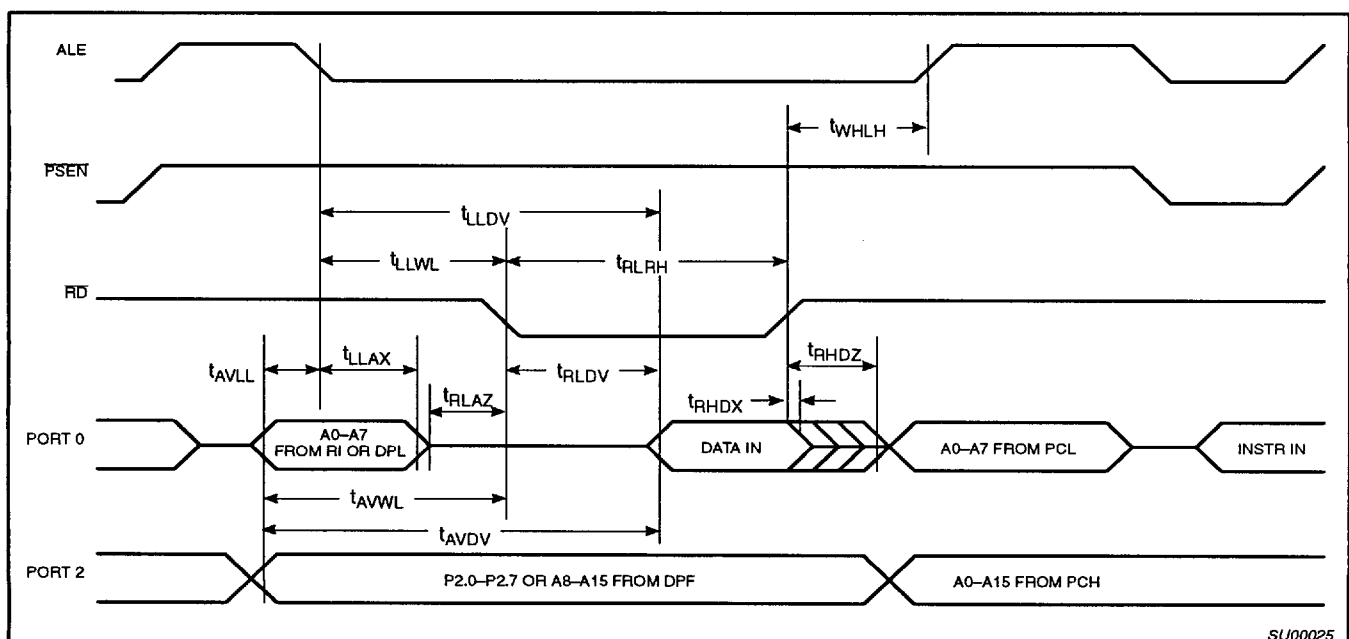


Figure 2. External Data Memory Read Cycle

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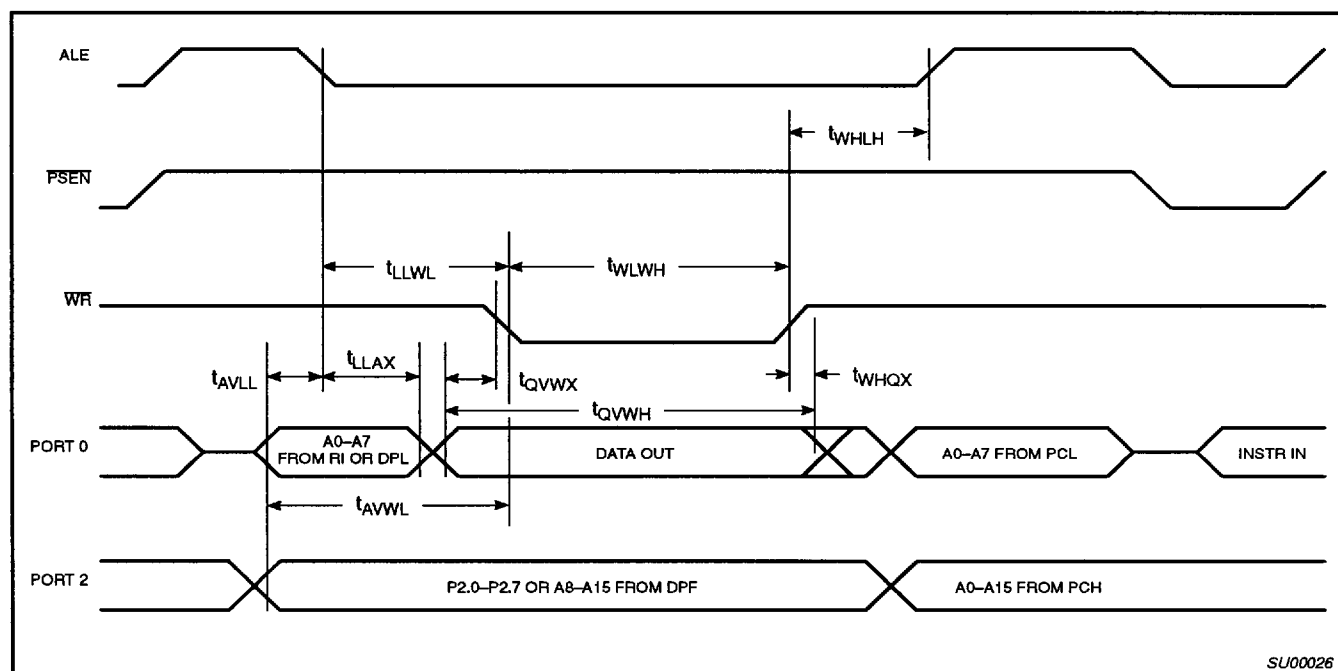


Figure 3. External Data Memory Write Cycle

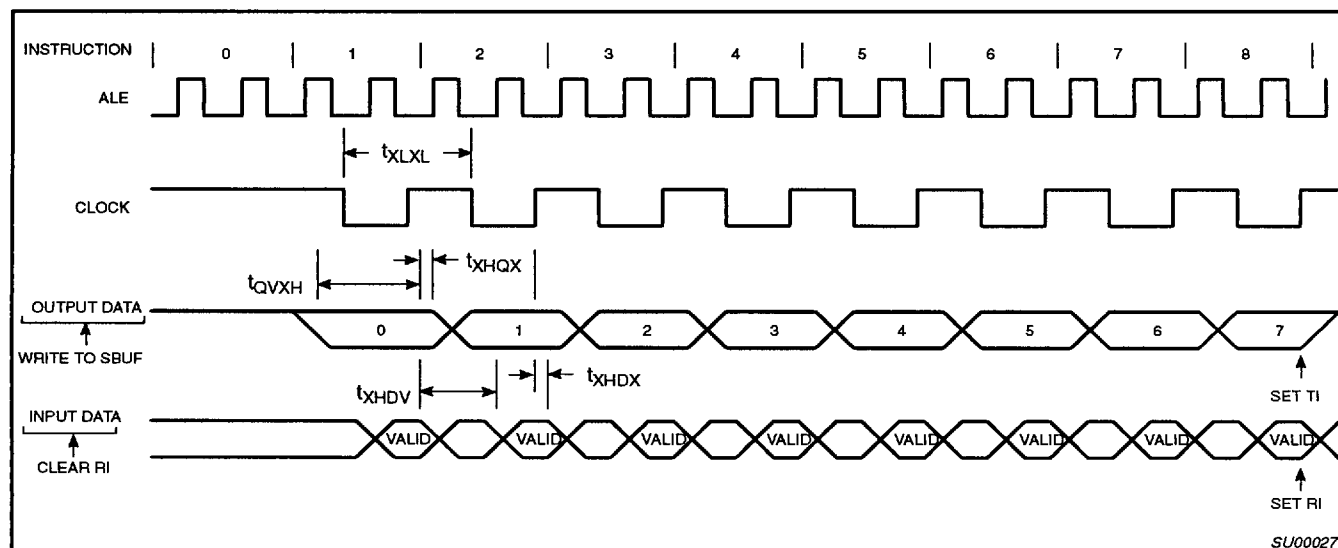


Figure 4. Shift Register Mode Timing

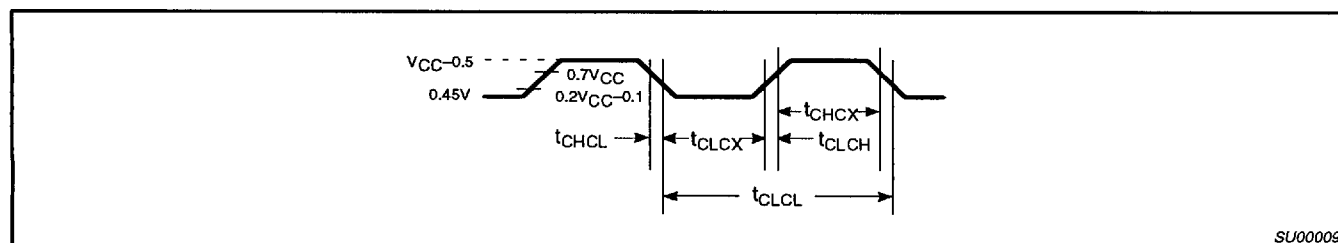
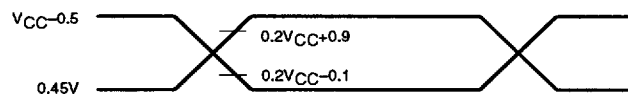


Figure 5. External Clock Drive

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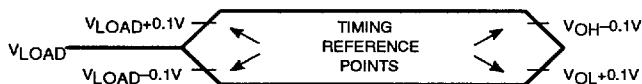


NOTE:

AC inputs during testing are driven at $V_{CC}-0.5$ for a logic '1' and 0.45V for a logic '0'.
Timing measurements are made at V_{IH} min for a logic '1' and V_{IL} max for a logic '0'.

SU00010

Figure 6. AC Testing Input/Output

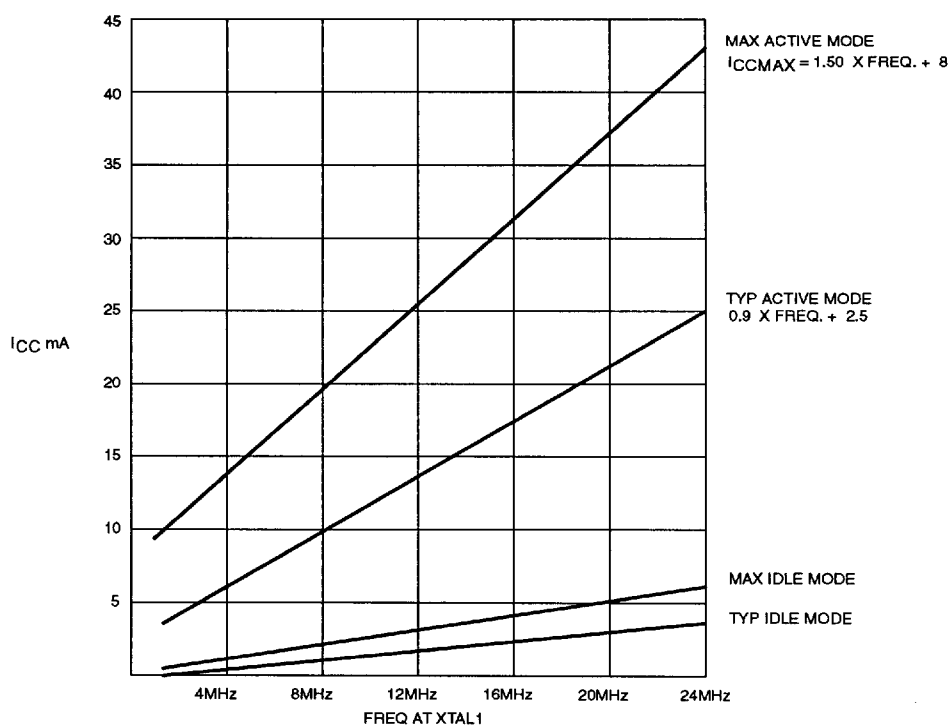


NOTE:

For timing purposes, a port is no longer floating when a 100mV change from load voltage occurs, and begins to float when a 100mV change from the loaded V_{OH}/V_{OL} level occurs. $I_{OH}/I_{OL} \geq \pm 20\text{mA}$.

SU00011

Figure 7. Float Waveform



SU00046

Figure 8. I_{CC} vs. FREQ Valid only within frequency specifications of the device under test

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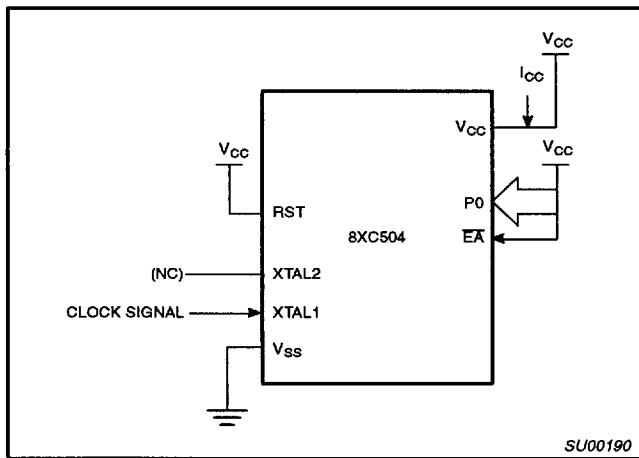


Figure 9. I_{CC} Test Condition, Active Mode
All other pins are disconnected

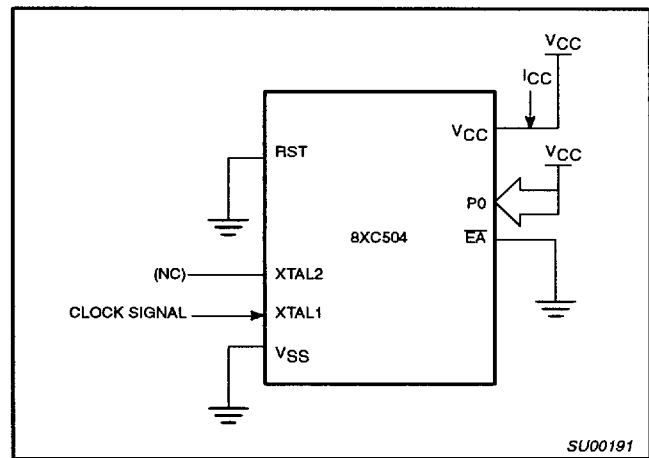


Figure 10. I_{CC} Test Condition, Idle Mode
All other pins are disconnected

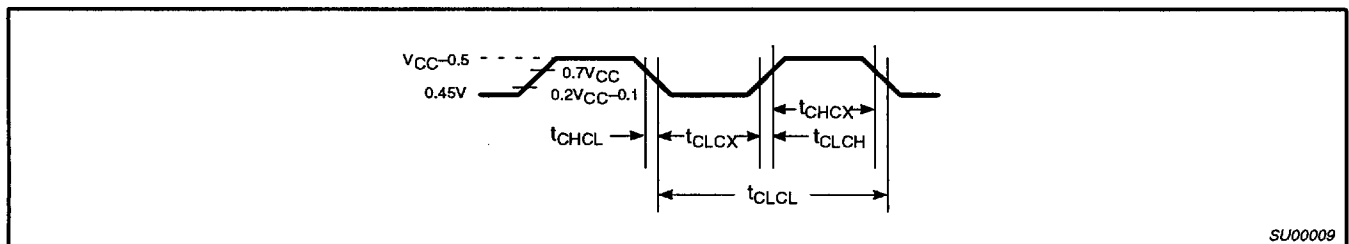


Figure 11. Clock Signal Waveform for I_{CC} Tests in Active and Idle Modes
 $t_{CLCH} = t_{CHCL} = 5\text{ns}$

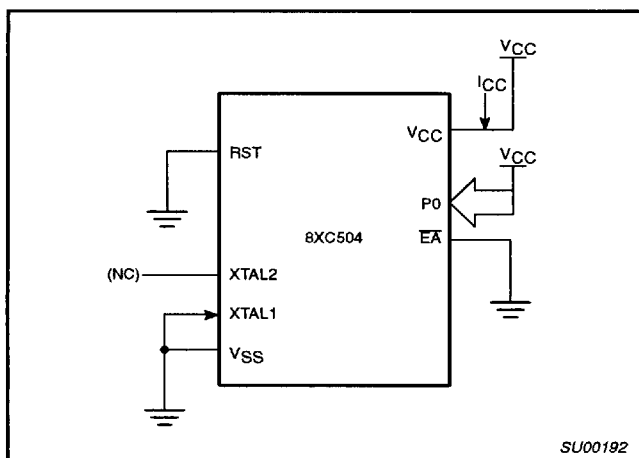


Figure 12. I_{CC} Test Condition, Power Down Mode
All other pins are disconnected. $V_{CC} = 2\text{V to } 5.5\text{V}$

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ROM CODE SUBMISSION

When submitting ROM code for the 83C504, the following must be specified:

1. 16k byte user ROM data
2. 32 byte ROM encryption key
3. ROM security bits.

If submitting a file, the format is as follows:

ADDRESS	CONTENT	BIT(S)	COMMENT
0000H to 4FFFH	DATA	7:0	User ROM Data
4000H to 401FH	KEY	7:0	ROM Encryption Key FFH = no encryption
4020H	SEC	0	ROM Security Bit 1 0 = enable security 1 = disable security
4020H	SEC	1	ROM Security Bit 2 0 = enable security 1 = disable security

Security Bit 1: When programmed, this bit has two effects on masked ROM parts:

1. External MOV_C is disabled, and
2. EA# is latched on Reset.

Security Bit 2: When programmed, this bit inhibits Verify User ROM.

If the ROM Code file does not include the options, the following information must be included with the ROM code.

For each of the following, check the appropriate box and send to Philips along with the code:

Security Bit #1: ☐ Enabled ☐ Disabled

Security Bit #2: ☐ Enabled ☐ Disabled

Encryption: ☐ No ☐ Yes If Yes, must send key file.

EPROM CHARACTERISTICS

The 87C504 is programmed by using a modified Quick-Pulse Programming™ algorithm. It differs from older methods in the value used for V_{PP} (programming supply voltage) and in the width and number of the ALE/PROG pulses.

The 87C504 contains two signature bytes that can be read and used by an EPROM programming system to identify the device. The signature bytes identify the device as an 87C504 manufactured by Philips.

Table 3 shows the logic levels for reading the signature byte, and for programming the program memory, the encryption table, and the security bits. The circuit configuration and waveforms for quick-pulse programming are shown in Figures 13 and 14. Figure 15 shows the circuit configuration for normal program memory verification.

Quick-Pulse Programming

The setup for microcontroller quick-pulse programming is shown in Figure 13. Note that the 87C504 is running with a 4 to 6MHz oscillator. The reason the oscillator needs to be running is that the device is executing internal address and program data transfers.

The address of the EPROM location to be programmed is applied to ports 1 and 2, as shown in Figure 13. The code byte to be programmed into that location is applied to port 0. RST, PSEN and pins of ports 2 and 3 specified in Table 3 are held at the 'Program Code Data' levels indicated in Table 3. The ALE/PROG is pulsed low 25 times as shown in Figure 14.

To program the encryption table, repeat the 25 pulse programming sequence for addresses 0 through 1FH, using the 'Pgm Encryption Table' levels. Do not forget that after the encryption table is programmed, verification cycles will produce only encrypted data.

To program the security bits, repeat the 25 pulse programming sequence using the 'Pgm Security Bit' levels. After one security bit is programmed, further programming of the code memory and encryption table is disabled. However, the other security bit can still be programmed.

Note that the EA/V_{PP} pin must not be allowed to go above the maximum specified V_{PP} level for any amount of time. Even a narrow glitch above that voltage can cause permanent damage to the device. The V_{PP} source should be well regulated and free of glitches and overshoot.

Program Verification

If security bit 2 has not been programmed, the on-chip program memory can be read out for program verification. The address of the program memory locations to be read is applied to ports 1 and 2 as shown in Figure 15. The other pins are held at the 'Verify Code Data' levels indicated in Table 3. The contents of the address location will be emitted on port 0. External pull-ups are required on port 0 for this operation.

If the encryption table has been programmed, the data presented at port 0 will be the exclusive NOR of the program byte with one of the encryption bytes. The user will have to know the encryption table

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contents in order to correctly decode the verification data. The encryption table itself cannot be read out.

Reading the Signature Bytes

The signature bytes are read by the same procedure as a normal verification of locations 030H and 031H, except that P3.6 and P3.7 need to be pulled to a logic low. The values are:

(030H) = 15H indicates manufactured by

Philips

(031H) = BBH indicates 87C504

Security Bits

With none of the security bits programmed the code in the program memory can be verified. If the encryption table is programmed, the code will be encrypted when verified. When only security bit 1 (see Table 4) is programmed, MOV_C instructions executed from external program memory are disabled from fetching code bytes from the internal memory, EA is latched on Reset and all further programming of the EPROM is disabled. When security bits 1 and 2 are programmed, in addition to the above, verify mode is disabled.

Program/Verify Algorithms

Any algorithm in agreement with the conditions listed in Table 3, and which satisfies the timing specifications, is suitable.

Table 3. EPROM Programming Modes

MODE	RST	PSEN	ALE/PROG	EA/V _{PP}	P2.7	P2.6	P3.7	P3.6
Read signature	1	0	1	1	0	0	0	0
Program code data	1	0	0*	V _{PP}	1	0	1	1
Verify code data	1	0	1	1	0	0	1	1
Pgm encryption table	1	0	0*	V _{PP}	1	0	1	0
Pgm security bit 1	1	0	0*	V _{PP}	1	1	1	1
Pgm security bit 2	1	0	0*	V _{PP}	1	1	0	0

NOTES:

1. '0' = Valid low for that pin, '1' = valid high for that pin.

2. V_{PP} = 12.75V ±0.25V.

3. V_{CC} = 5V ±10% during programming and verification.

* ALE/PROG receives 25 programming pulses while V_{PP} is held at 12.75V. Each programming pulse is low for 100µs (±10µs) and high for a minimum of 10µs.

Table 4. Program Security Bits

PROGRAM LOCK BITS ^{1, 2}			PROTECTION DESCRIPTION
	SB1	SB2	
1	U	U	No Program Lock features enabled. (Code verify will still be encrypted by the Encryption Array if programmed.)
2	P	U	MOV _C instructions executed from external program memory are disabled from fetching code bytes from internal memory, EA is sampled and latched on Reset, and further programming of the EPROM is disabled.
3	P	P	Same as 2, also verify user program is disabled.

NOTES:

1. P – programmed. U – unprogrammed.

2. Any other combination of the lock bits is not defined.

Erase Characteristics

Erase of the EPROM begins to occur when the chip is exposed to light with wavelengths shorter than approximately 4,000 angstroms. Since sunlight and fluorescent lighting have wavelengths in this range, exposure to these light sources over an extended time (about 1 week in sunlight, or 3 years in room level fluorescent lighting) could cause inadvertent erasure. **For this and secondary effects, it is recommended that an opaque label be placed over the window.** For elevated temperature or environments where solvents are being used, apply Kapton tape Fluorglas part number 2345-5, or equivalent.

The recommended erasure procedure is exposure to ultraviolet light (at 2537 angstroms) to an integrated dose of at least 15W-s/cm². Exposing the EPROM to an ultraviolet lamp of 12,000µW/cm² rating for 20 to 39 minutes, at a distance of about 1 inch, should be sufficient.

Erase leaves the array in an all 1s state.

TMTrademark phrase of Intel Corporation.

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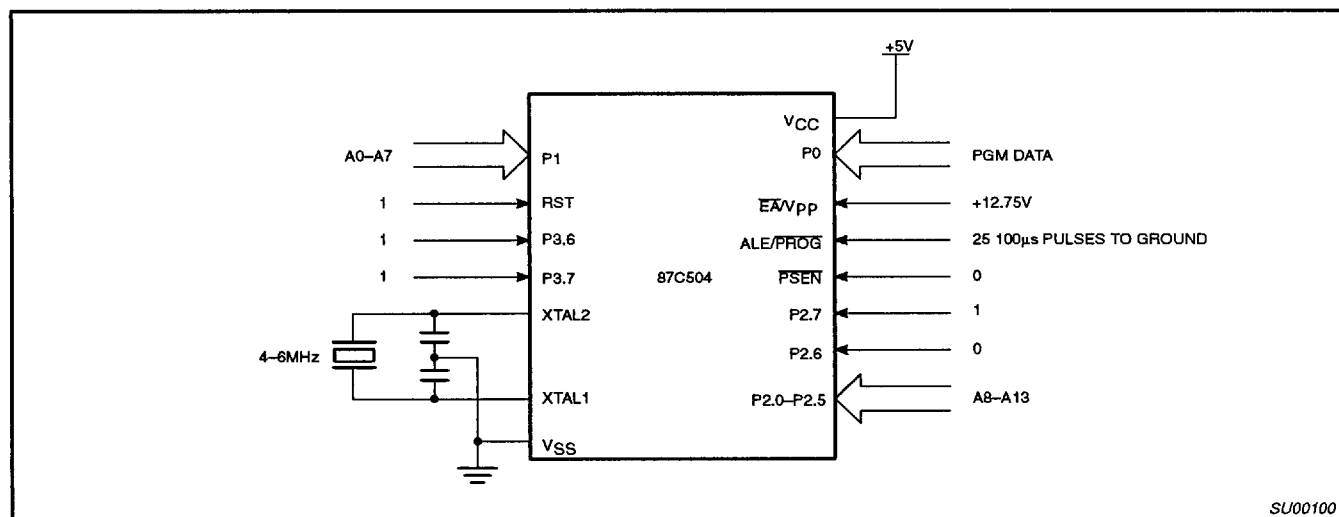


Figure 13. Programming Configuration

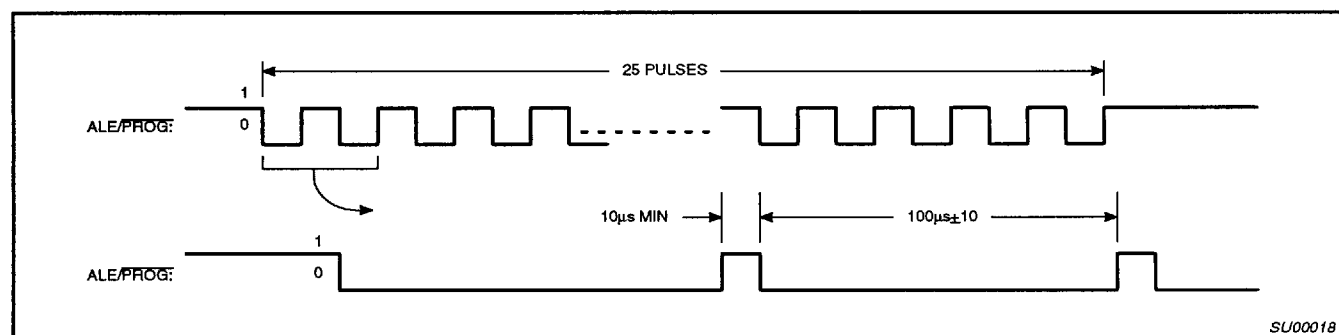


Figure 14. PROG Waveform

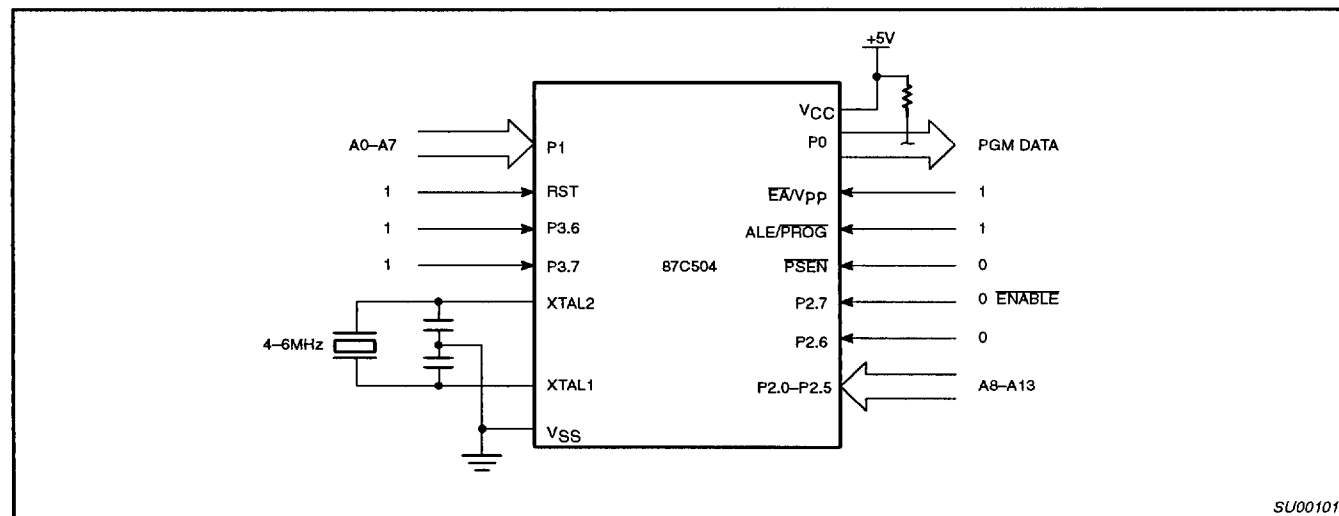


Figure 15. Program Verification

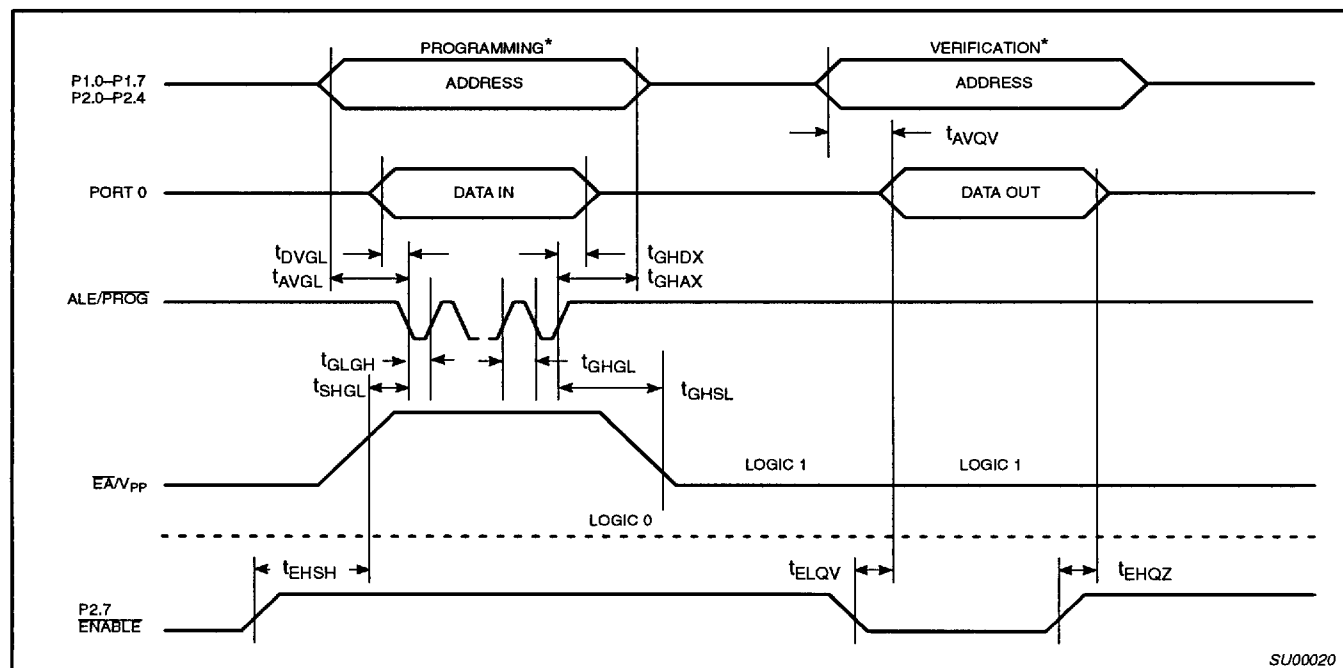
CMOS single-chip 8-bit microcontroller

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EPROM PROGRAMMING AND VERIFICATION CHARACTERISTICS

 $T_{amb} = 21^{\circ}\text{C}$ to $+27^{\circ}\text{C}$, $V_{CC} = 5\text{V} \pm 10\%$, $V_{SS} = 0\text{V}$ (See Figure 16)

SYMBOL	PARAMETER	MIN	MAX	UNIT
V_{PP}	Programming supply voltage	12.5	13.0	V
I_{PP}	Programming supply current		50	mA
$1/t_{CLCL}$	Oscillator frequency	4	6	MHz
t_{AVGL}	Address setup to $\overline{\text{PROG}}$ low	$48t_{CLCL}$		
t_{GHAX}	Address hold after $\overline{\text{PROG}}$	$48t_{CLCL}$		
t_{DVGL}	Data setup to $\overline{\text{PROG}}$ low	$48t_{CLCL}$		
t_{GHDX}	Data hold after $\overline{\text{PROG}}$	$48t_{CLCL}$		
t_{EHS}	P2.7 (ENABLE) high to V_{PP}	$48t_{CLCL}$		
t_{SHGL}	V_{PP} setup to $\overline{\text{PROG}}$ low	10		μs
t_{GHSL}	V_{PP} hold after $\overline{\text{PROG}}$	10		μs
t_{GLGH}	$\overline{\text{PROG}}$ width	90	110	μs
t_{AVQV}	Address to data valid		$48t_{CLCL}$	
t_{ELQZ}	ENABLE low to data valid		$48t_{CLCL}$	
t_{EHQZ}	Data float after ENABLE	0	$48t_{CLCL}$	
t_{GHGL}	$\overline{\text{PROG}}$ high to $\overline{\text{PROG}}$ low	10		μs



SU00020

NOTE:

- * FOR PROGRAMMING VERIFICATION SEE FIGURE 13.
FOR VERIFICATION CONDITIONS SEE FIGURE 15.

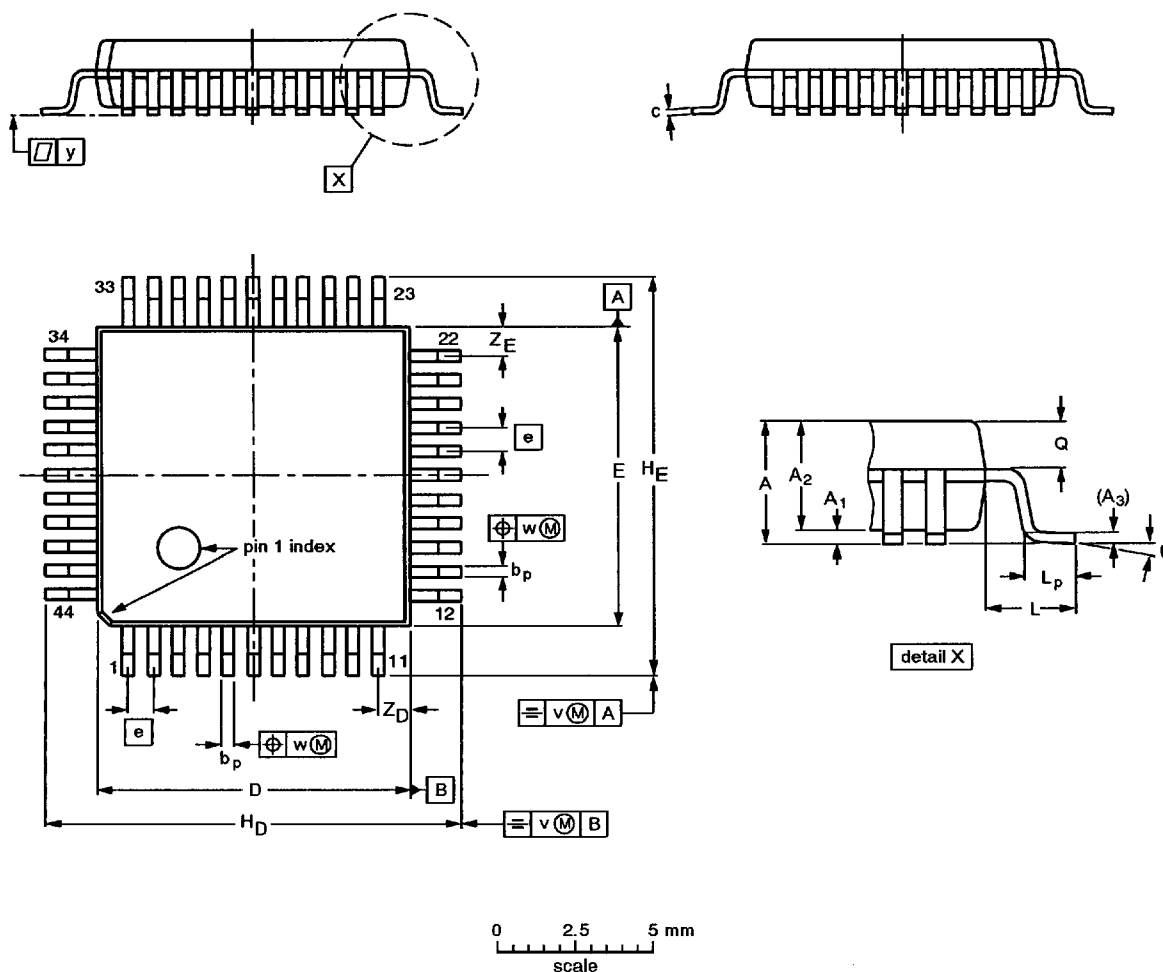
Figure 16. EPROM Programming and Verification

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LQFP44: plastic low profile quad flat package; 44 leads; body 10 x 10 x 1.4 mm

SOT389-1

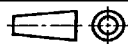


DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _D	H _E	L	L _p	Q	v	w	y	Z _D ⁽¹⁾	Z _E ⁽¹⁾	θ
mm	1.60	0.15 0.05	1.45 1.35	0.25	0.45 0.30	0.20 0.12	10.10 9.90	10.10 9.90	0.80	12.15 11.85	12.15 11.85	1.0	0.75 0.45	0.70 0.57	0.20	0.20	0.10	1.14 0.85	1.14 0.85	7° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

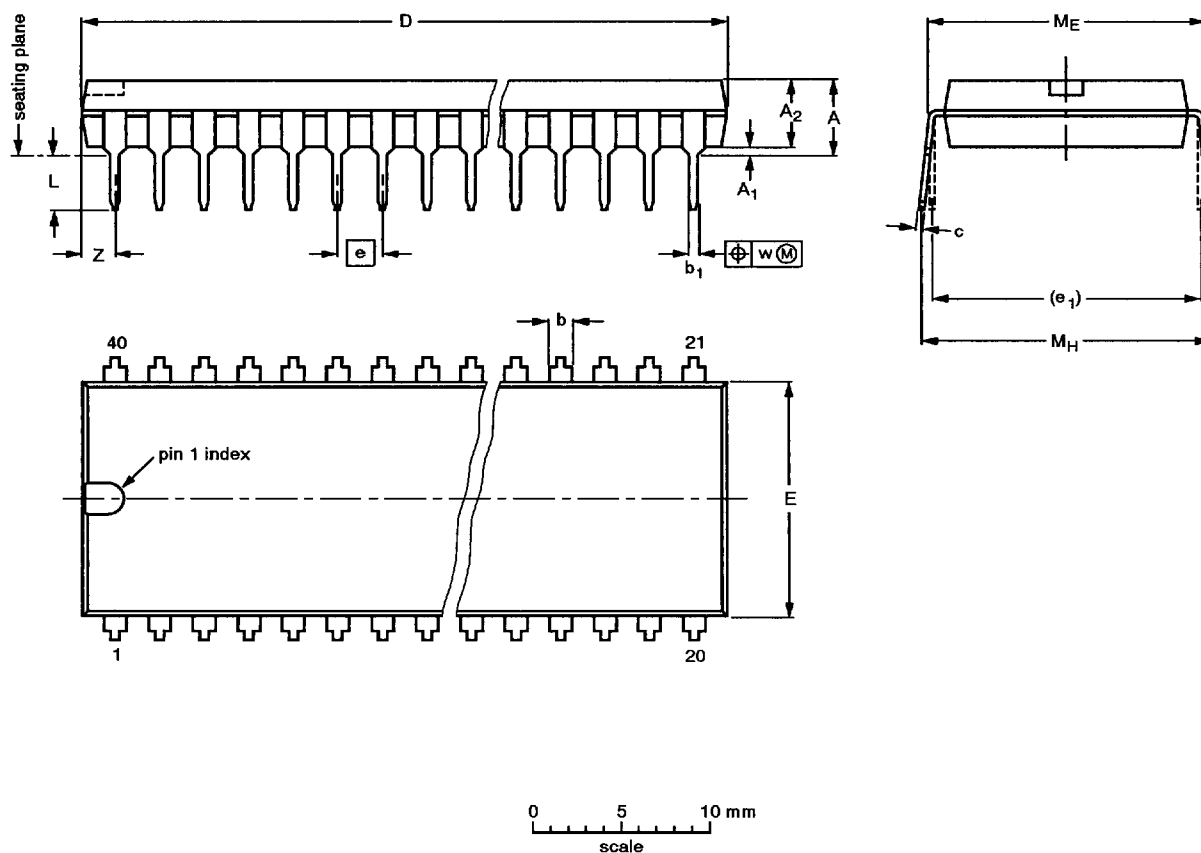
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT389-1						95-02-25

CMOS single-chip 8-bit microcontroller

83C504/87C504

DIP40: plastic dual in-line package; 40 leads (600 mil)

SOT129-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.7	0.51	4.0	1.70 1.14	0.53 0.38	0.36 0.23	52.50 51.50	14.1 13.7	2.54	15.24	3.60 3.05	15.80 15.24	17.42 15.90	0.254	2.25
inches	0.19	0.020	0.16	0.067 0.045	0.021 0.015	0.014 0.009	2.067 2.028	0.56 0.54	0.10	0.60	0.14 0.12	0.62 0.60	0.69 0.63	0.01	0.089

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT129-1	051G08	MO-015AJ				92-11-17 95-01-14

83C504/87C504

40-PIN (600 mils wide) CERAMIC DUAL IN-LINE (F) PACKAGE (WITH WINDOW (FA) PACKAGE)

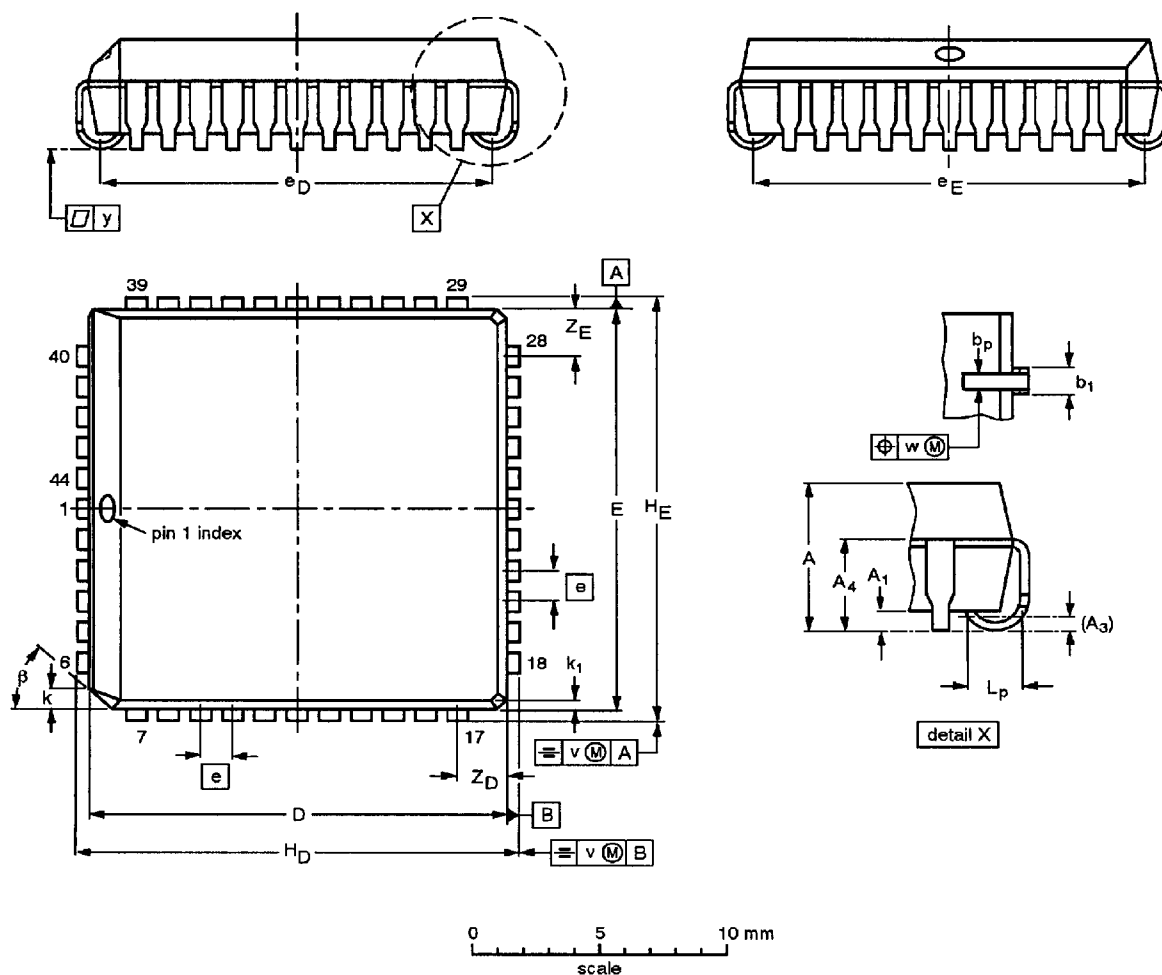


CMOS single-chip 8-bit microcontroller

83C504/87C504

PLCC44: plastic leaded chip carrier; 44 leads

SOT187-2



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	A ₁ min.	A ₃	A ₄ max.	b _p	b ₁	D ⁽¹⁾	E ⁽¹⁾	e	e _D	e _E	H _D	H _E	k	k ₁ max.	L _p	v	w	y	z _D ⁽¹⁾ max.	z _E ⁽¹⁾ max.	β
mm	4.57 4.19	0.51	0.25	3.05	0.53 0.33	0.81 0.66	16.66 16.51	16.66 16.51	1.27	16.00 14.99	16.00 14.99	17.65 17.40	17.65 17.40	1.22 1.07	0.51	1.44 1.02	0.18	0.18	0.10	2.16	2.16	45°
inches	0.180 0.165	0.020	0.01	0.12	0.021 0.013	0.032 0.026	0.656 0.650	0.656 0.650	0.05	0.630 0.590	0.630 0.590	0.695 0.685	0.695 0.685	0.048 0.042	0.020	0.057 0.040	0.007	0.007	0.004	0.085	0.085	

Note

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT187-2	112E10	MO-047AC				92-11-17 95-02-25

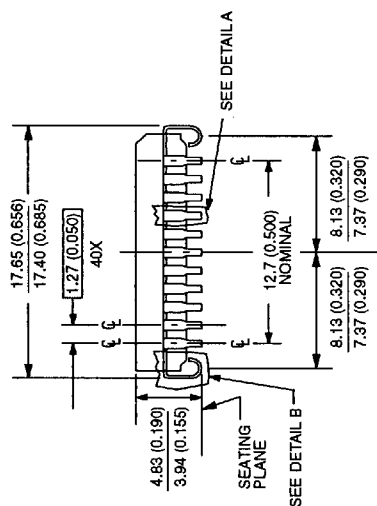
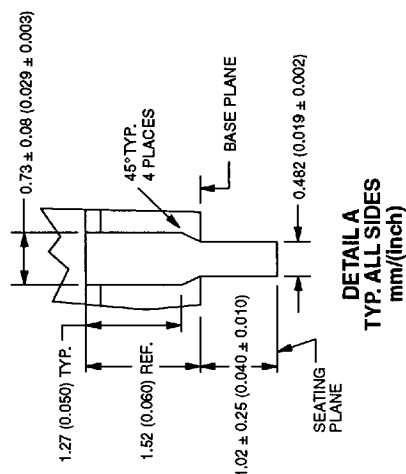
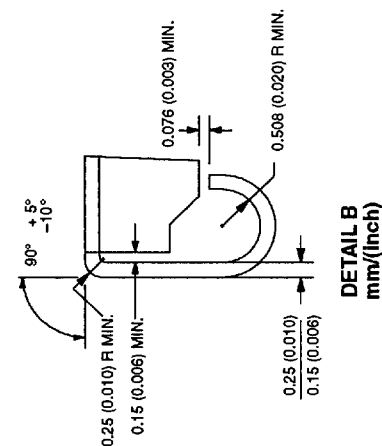
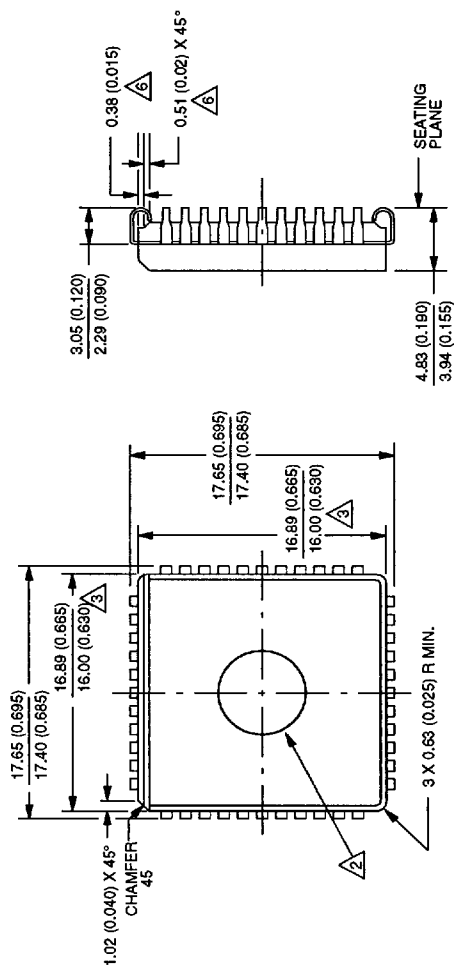
CMOS single-chip 8-bit microcontroller

83C504/87C504

1472A 44-PIN CERQUAD J-BEND (K) PACKAGE

NOTES:

1. All dimensions and tolerances to conform to ANSI Y14.5-1982.
2. UV window is optional.
3. Dimensions do not include glass protrusion. Glass protrusion to be 0.005 inches maximum on each side.
4. Controlling dimension millimeters.
5. All dimensions and tolerances include lead trim offset and lead plating finish.
6. Backside solder relief is optional and dimensions are for reference only.



853-1472A 05854